

# Piezoelectric Chip, 45 V, 2.0 µm Travel

PA1CE



### Description

The PA1CE piezoelectric chip consists of stacked piezoelectric ceramic layers (which are mechanically in series) that are sandwiched between interdigitated electrodes (which are electrically in parallel). It offers a maximum displacement of 2.0  $\mu$ m  $\pm$  15%. A black dot is located next to the electrode that should receive positive bias; the other electrode should be grounded. The electrodes are bare.

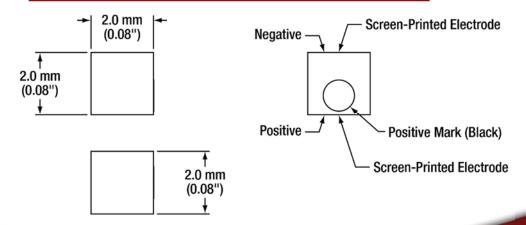
## **Specifications**

PA1CE <sup>a</sup>	
Drive Voltage Range	0 to 45 V
Displacement (Free Stroke) at 45 V	2.0 µm ± 15%
Hysteresis	<15% (See Graph on Next Page)
Load for Maximum Displacement <sup>b</sup>	65 N (15 lbs)
Blocking Force at 45 V	160 N (36 lbs)
Resonant Frequency	540 kHz (No Load)
Impedance at Resonant Frequency	400 mΩ
Anti-Resonant Frequency	705 kHz
Dissipation Factor <sup>c</sup>	<4.0%
Capacitance <sup>c</sup>	215 nF ± 15%
Operating Temperature	-25 to 130 °C
Curie Temperature	230 °C
External Electrodes	Screen-Printed Silver
	Width 1: 2.0 mm ± 0.1 mm
Dimensions	Width 2: 2.0 mm ± 0.1 mm
	Height: 2.0 mm ± 5 μm



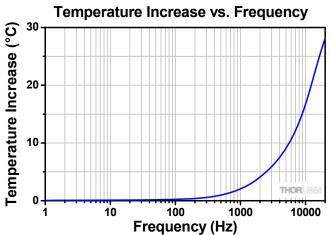
- a. All specifications are quoted at 25 °C, unless otherwise stated.
- b. The displacement may vary slightly for different loads, and the maximum displacement occurs when the load for maximum displacement is used.
- Specified at 1 kHz, 1 V<sub>RMS</sub>

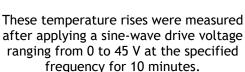
# Drawing

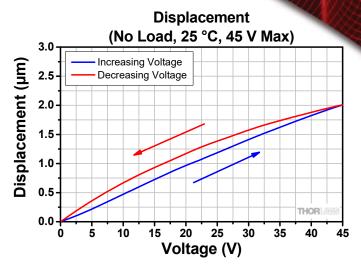




## Typical Performance Plots







### **Operation**

#### **Electrical Considerations**

- The electrode closest to the black dot should be positively biased, and the opposite electrode should be grounded. The maximum drive voltage is 45 V. Exceeding 45 V will decrease the device's lifespan and may cause mechanical failure. Reverse biasing may cause mechanical failure.
- When soldering wires to the electrodes, use a temperature no greater than 370 °C (700 °F) for a maximum of 2 seconds per spot. Solder to the middle of the electrode, keeping the spot as small as possible.
- Caution: After driving, the piezo is fully charged. Directly connecting the positive and negative electrodes has the risk of electricity discharging, spark, and even failure. We recommend using a resistor (>1  $k\Omega$ ) between the electrodes to release the charge.

#### Attaching Devices to the Piezo

- Any epoxy which cures at a temperature lower than 80 °C is safe to use. We recommend Thorlabs item # 353NDPK or TS10. Loctite Hysol 9340 can also be used.
- Loads should only be attached to the central area of the chip face since the edges do not translate. Attaching a load to the non-translating faces may lead to mechanical failure.

#### Storage Instructions

- Do not store the device at temperatures above 80 °C.
- Do not store the device in humid environments. The relative humidity (RH) should be less than 40%.
- Do not immerse the device in organic solvents.
- Do not use the device around combustible gases or liquids.